

150V, 54A, 16mΩ N-channel Power SGT MOSFET

JMSH1516PG

Features

- $\bullet \;\;$ Excellent $R_{\text{DS(ON)}}$ and Low Gate Charge
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant

Applications

- Load Switch
- PWM Application
- Power Management

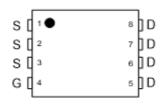
Product Summary

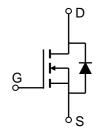
Parameters	Value	Unit
V_{DSS}	150	V
$V_{GS(th)_Typ}$	3.1	V
$I_D(@V_{GS}=10V)$	54	Α
$R_{DS(ON)_Typ}(@V_{GS}=10V$	16	mΩ











PDFN5X6-8L

Pin Assignment

Schematic Diagram

Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMSH1516PG-13	SH1516P	1	Tape&Reel	PDFN5x6-8L	5000	50000

Absolute Maximum Ratings (@ $T_C = 25$ °C unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{DS}	Drain-to-Source Voltage		150	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	$T_C = 25^{\circ}C$	54	Λ
I _D		$T_C = 100$ °C	34	А
I _{DM}	Pulsed Drain Current (1)		Refer to Fig.4	Α
E _{AS}	Single Pulsed Avalanche Energ	ly ⁽²⁾	238	mJ
P _D	Power Dissipation	$T_C = 25^{\circ}C$	125	W
		$T_C = 100$ °C	50	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
T_{J}, T_{STG}	Junction & Storage Temperature F	Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽³⁾	43	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.0	C/VV



Electrical Characteristics (T_J = 25°C unless otherwise specified)

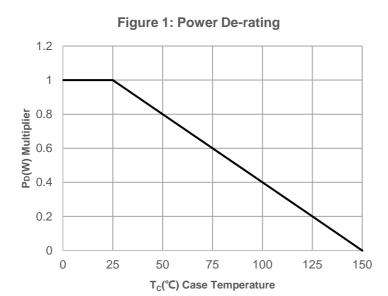
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	racteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	150	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 120V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.1	3.1	4.0	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = 10V, I_D = 20A$	-	16	20	mΩ
Dynami	c Characteristics					
R_{g}	Gate Resistance	f = 1MHz	-	0.7	-	Ω
C _{iss}	Input Capacitance		1635	2290	3091	pF
C _{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 75V,$ f = 1MHz	150	210	284	pF
C _{rss}	Reverse Transfer Capacitance	1 - 11/11/2	13	18	24	pF
Qg	Total Gate Charge		23	32	43	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 75V, I_D = 20A$	9	13	17	nC
Q_{gd}	Gate Drain("Miller") Charge	V DS = 73 V, 10 = 207	-	6	-	nC
0:(-1.:	to a Oh ana stanistica					
	ng Characteristics Turn-On DelayTime	1		15	_	
t _{d(on)}	, , , , , , , , , , , , , , , , , , ,					ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 75V$ $I_{D} = 20A, R_{GEN} = 3\Omega$	-	19	-	ns
t _{d(off)}	Turn-Off DelayTime	ID- 20A, NGEN - 352	-	22	-	ns
t _f	Turn-Off Fall Time		-	5	-	ns
	iode Characteristics	Current			E 4	
I _S	Maximum Continuous Body Diode Forward Current		-	-	54	A
I _{SM}	Maximum Pulsed Body Diode Forward Curre		-	-	215	A
V _{SD}	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-		1.2	V
trr	Body Diode Reverse Recovery Time	I _F = 20A, di/dt = 100A/us	57	80	108	ns
Qrr	Body Diode Reverse Recovery Charge		-	205	-	nC

Notes:

- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- $2.\ E_{AS}\ condition:\ Starting\ T_J=25C,\ V_{DD}=75V,\ V_{GS}=10V,\ R_G=25ohm,\ L=3mH,\ I_{AS}=30.1A,\ V_{DD}=0V\ during\ time\ in\ avalanche.$
- 3. $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.
- 4. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 0.5%.



Typical Performance Characteristics



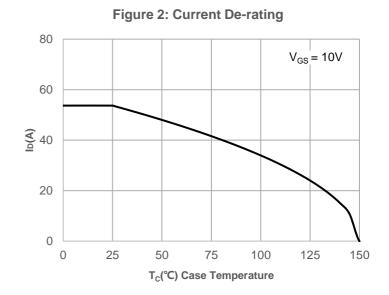
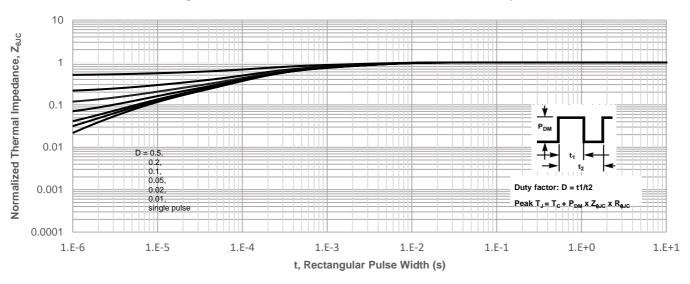
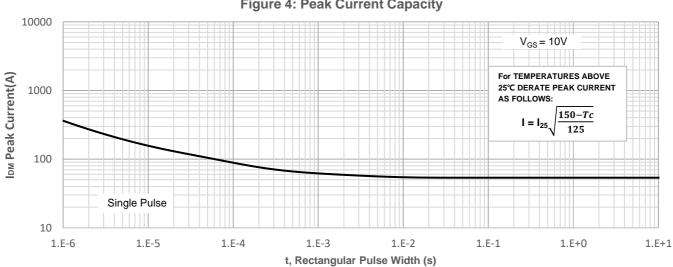


Figure 3: Normalized Maximum Transient Thermal Impedance







Typical Performance Characteristics

Figure 5: Output Characteristics

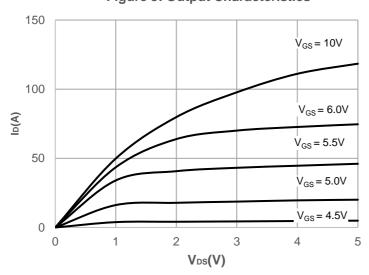


Figure 6: Typical Transfer Characteristics

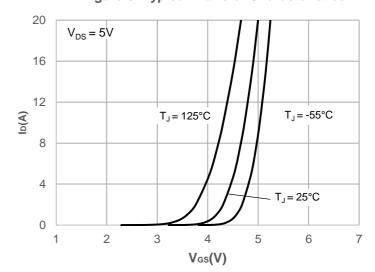


Figure 7: On-resistance vs. Drain Current

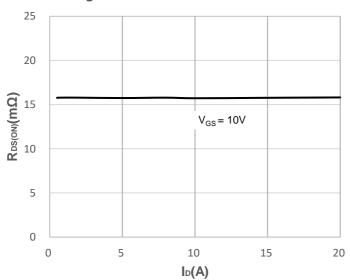


Figure 8: Body Diode Characteristics

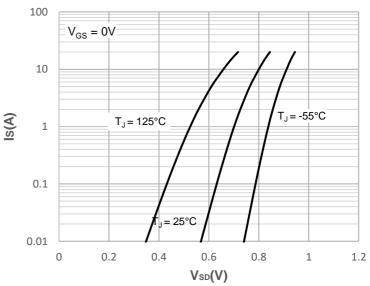


Figure 9: Gate Charge Characteristics

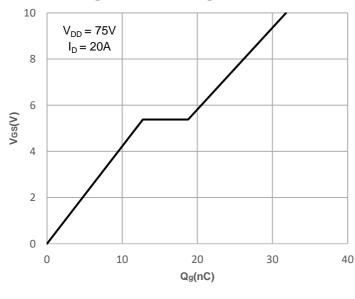
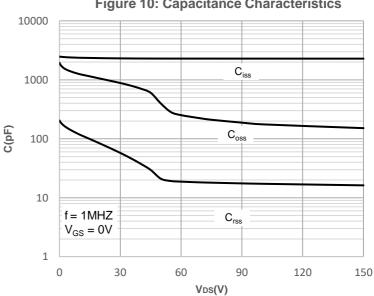


Figure 10: Capacitance Characteristics



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Typical Performance Characteristics

Figure 11: Normalized Breakdown voltage vs. Junction Temperature

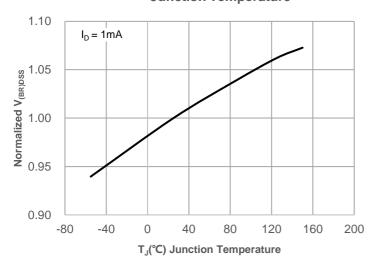


Figure 13: Normalized Threshold Voltage vs. Junction Temperature

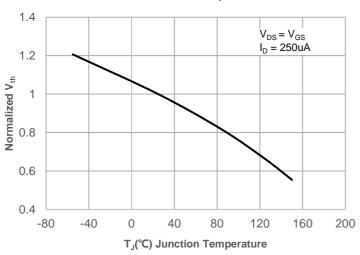


Figure 15: Maximum Safe Operating Area

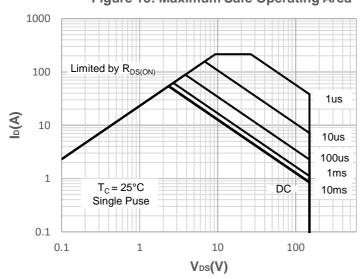
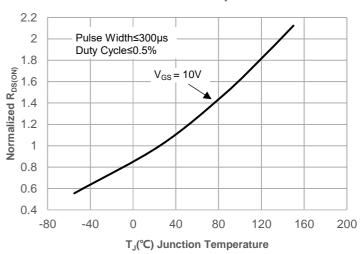
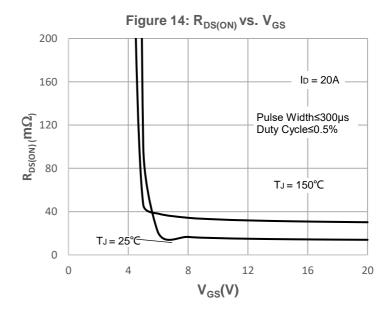


Figure 12: Normalized on Resistance vs. Junction Temperature







Test Circuit

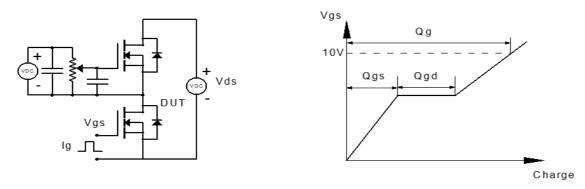


Figure 1: Gate Charge Test Circuit & Waveform

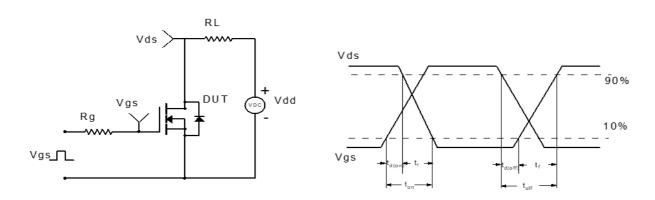


Figure 2: Resistive Switching Test Circuit & Waveform

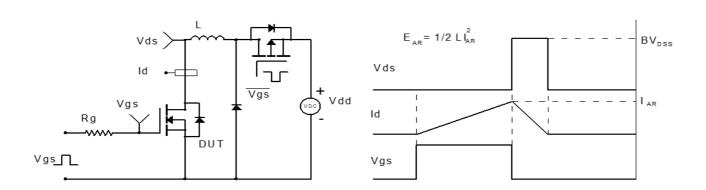


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

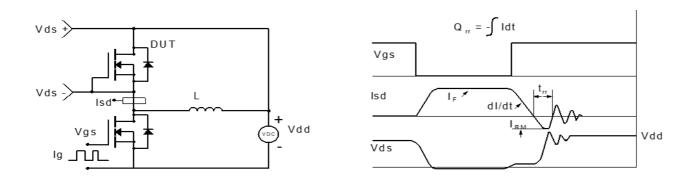


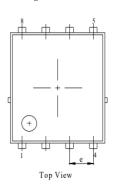
Figure 4: Diode Recovery Test Circuit & Waveform

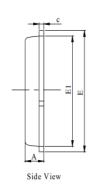
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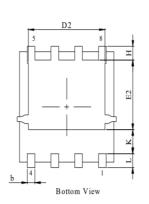


Package Mechanical Data(PDFN5x6-8L)

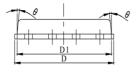
Package Outline







7.71/	MILLIMETER				
DIM.	MIN.	NOM.	MAX.		
A	0. 9	1	1. 15		
b	0. 31	0.41	0.51		
С	0. 24	0. 32	0. 4		
D	5	5. 2	5. 4		
D 1	4. 95	5. 05	5. 15		
D2	4	4. 1	4. 2		
E	6. 05	6. 15	6. 25		
E1	5. 5	5. 6	5. 7		
E2	3. 42	3, 53	3. 63		
е	1. 27BSC				
Н	0.6	0. 7	0.8		
L	0.5	0. 7	0.8		
K	1.23 REF				
0			10		

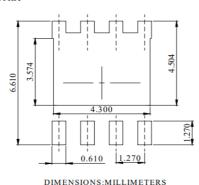


Front View

NOTES:

- Dimension and tolerance per ASME Y14.5M, 1994. All dimensions in millimeter (angle in degree). Dimensions D1 and E1 do not include mold flash protrusions or gate burrs.

Recommended Soldering Footprint



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